Micromax™ LF500

Electronic Inks and Pastes

Encapsulant Paste

Micromax™ LF500 is a low temperature encapsulant for nitrogen fired materials, compatible with Micromax™ copper conductors and Micromax™ QP60 Resistors Series. When used as a resistor encapsulant, Micromax™ LF500 can be laser trimmed.

Product information

Solvent or thinner	Micromax™ 5928	
Solid content	76 - 79[1]	%

[1]: 750°C

Rheological properties

Viscosity	50 - 80	Pa.s

Application technique

Mask mesh	325	
Mask emulsion	10 - 15	µm
Drying time	10	min
Drying temperature	120	°C
Leveling time	5 - 10	min

Storage and stability

Shelf life	6[2]	months

[2]: in unopened containers, from date of shipment, at temperature <25°C

Additional information

How to use

Processing

- Substrates
  - Properties are based on tests on 96% alumina substrates. Substrates of other compositions and from various manufacturers may result in variations in performance properties.
- Printing
  - A 325 mesh stainless steel screen with a 10-15µm emulsion thickness is recommended. Printing speeds up to 25 cm/s can be used.
- Drying
  - Allow prints to level for 5-10 minutes at room temperature. Dry 10 minutes at 120°C in air. Drying above 150°C in air will oxidize the copper and affect the surface properties of the fired film.

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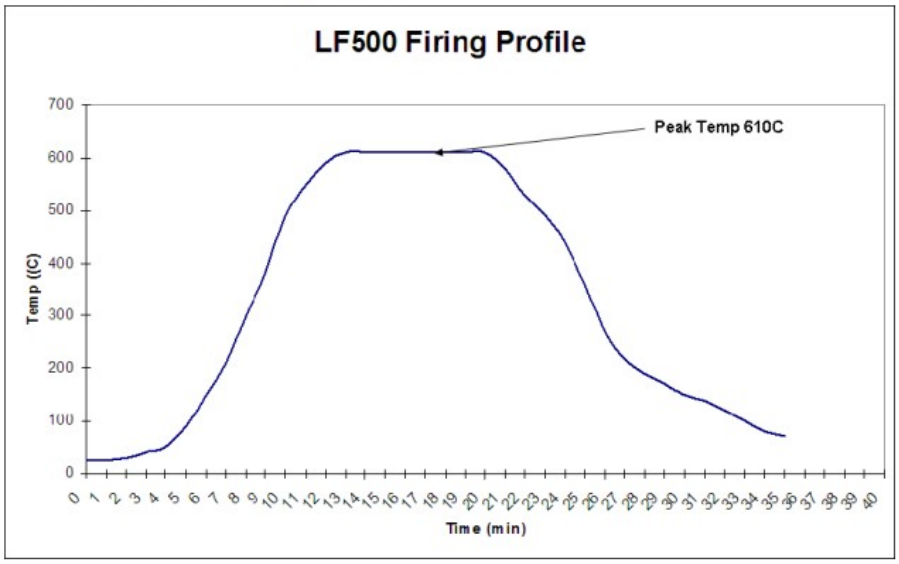
- Firing
  - Dried parts should be fired in a belt furnace. A total cycle time of 30 minutes and peak temperature of 610°C for 10 minutes is recommended. Nitrogen atmosphere must be used with a prevailing oxygen level of 5-10 ppm.

Recommended Firing Profile



Properties

Typical Physical Properties

Test	Properties
Black Speck (µm)	37

Information in this datasheet shows anticipated typical physical properties for Micromax™ LF500 based on specific controlled experiments in our labs and are not intended to represent the product specifications, details of which are available upon request.

Storage and shelf life

Containers should be stored, tightly sealed, in a clean, stable environment at room temperature (<25°C). Shelf life of material in unopened containers is six months from date of shipment. Some settling of solids may occur and compositions should be thoroughly mixed prior to use.

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Safety and handling

For safety and handling information pertaining to this product, read Safety Data Sheet (SDS).

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